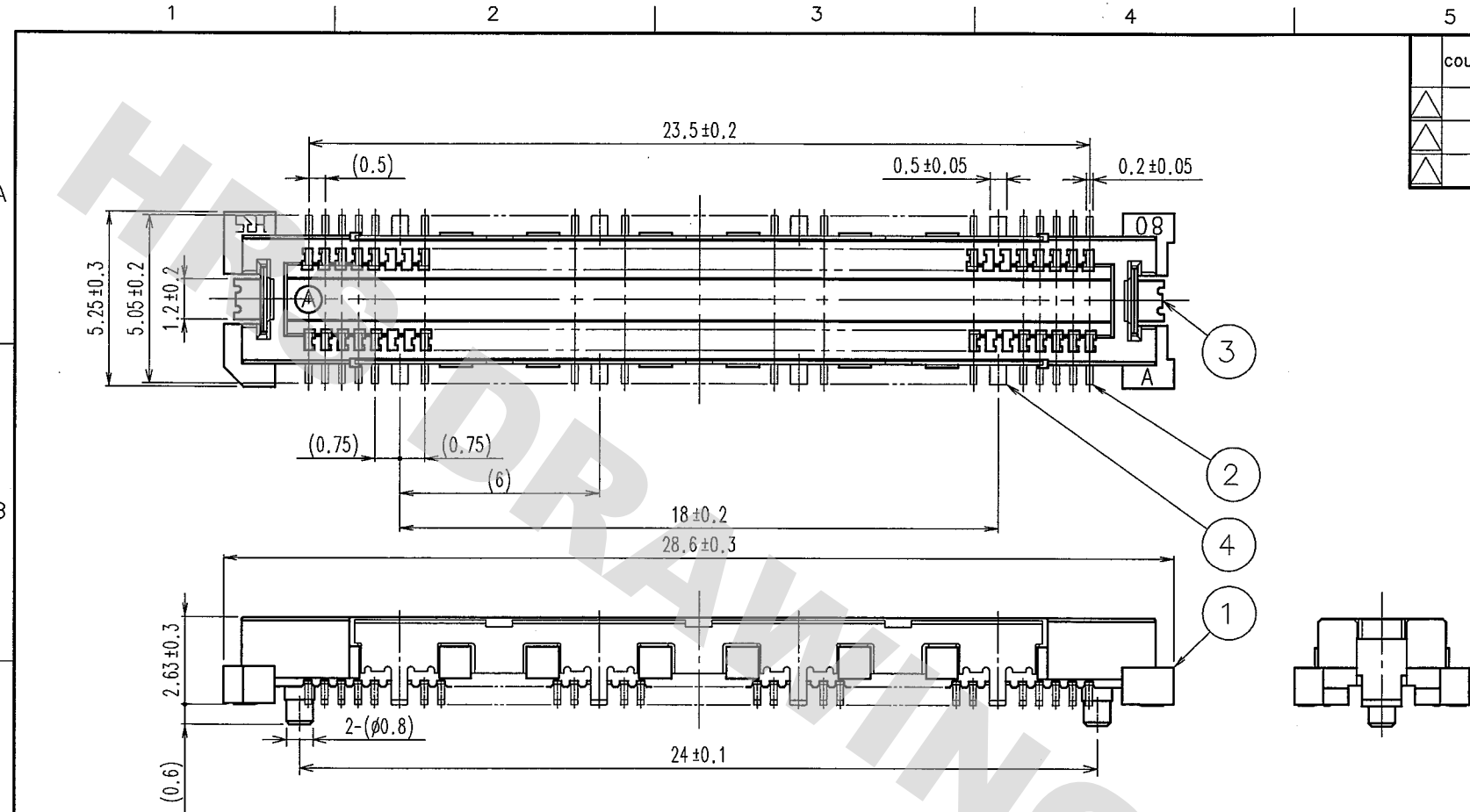
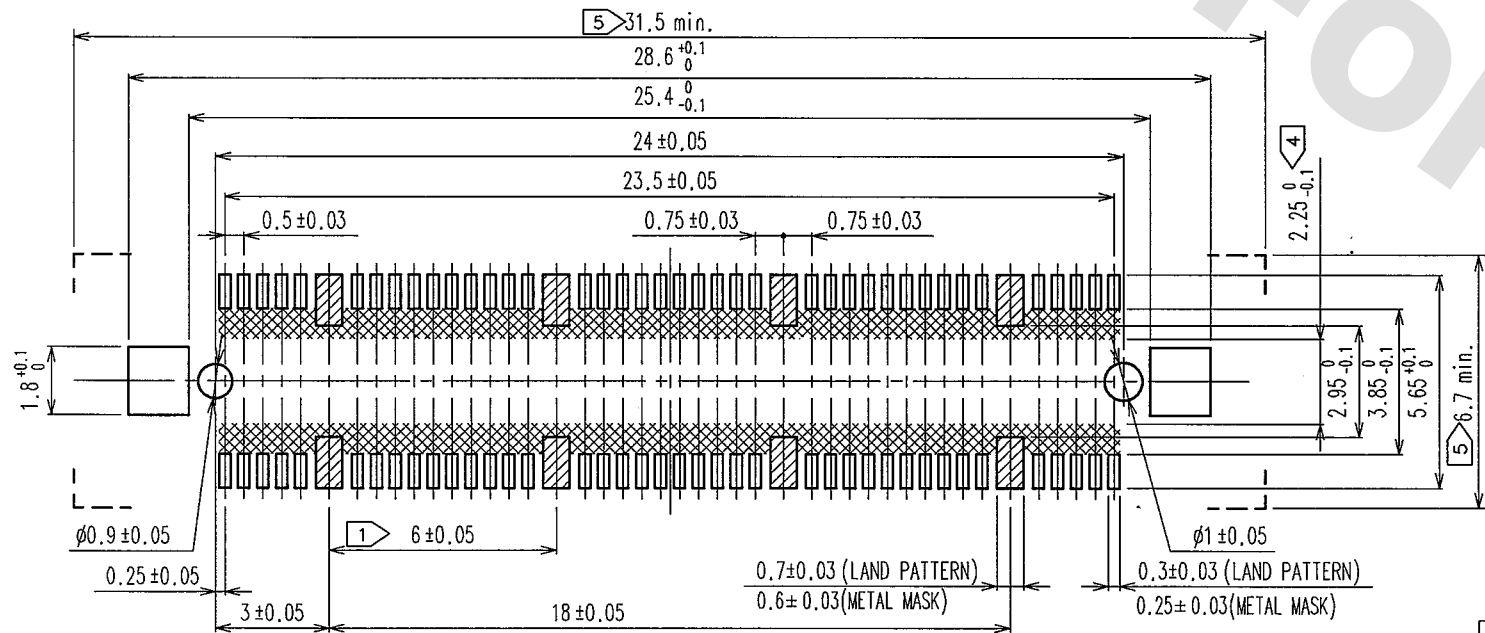


DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012

TO

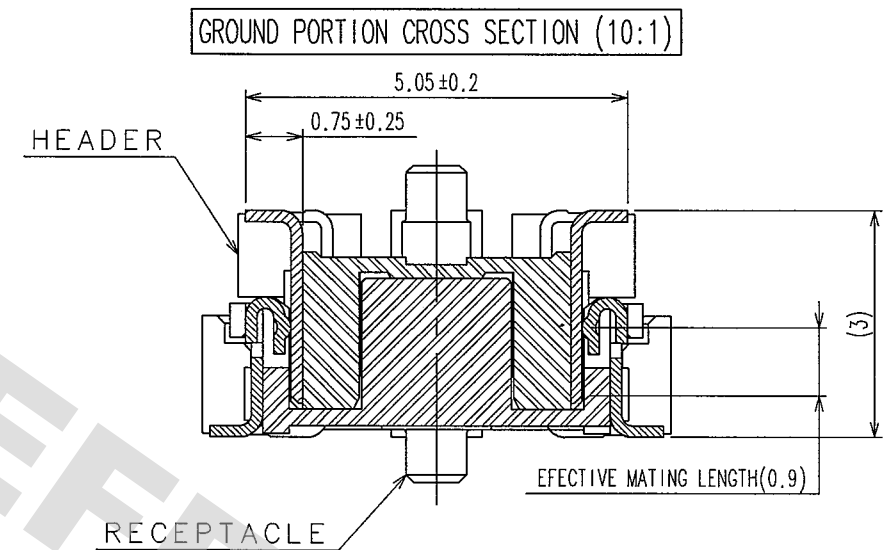
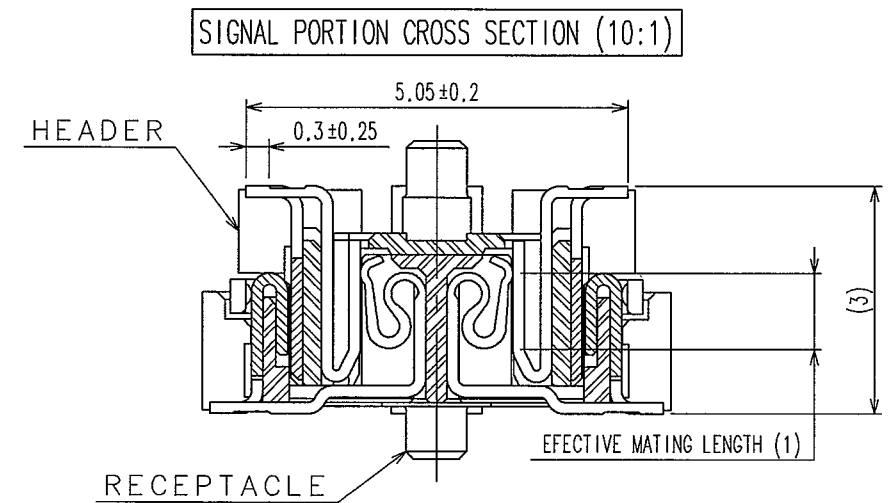


RECOMMENDED LAND PATTERN DIMENSION OF PCB



- NOTES
- 1 8 HATCHED PARTS: GROUND CIRCUIT.
 - 2 SMT LEAD-COPLANARITY: 0.1 MAX.
 - 3 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - 4 MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - 5 DO NOT MOUNT OTHER DEVICES INSIDE □ AREA, OR MATING PAIR CANNOT BE MATED.
 - 6 DIMENSIONS IN PARENTHESIS ARE FOR REFERENCE.

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△					△				
△					△				
△					△				



3,4	PHOSPHOR BRONZE	TIN PLATING	2	COPPER ALLOY	CONTACT AREA: GOLD 0.1μmin.
1	LCP	BEIGE UL94V-0			MOUNTING AREA: GOLD FLASH
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	UNDER PLATING: NICKEL 1μmin.
CODE NO. (OLD)	CL	DRAWN	DESIGNED	CHECKED	APPROVED
		T.NODA	J. Noda	H. Ogawa	H. Okawa
		'05.09.22	'05.09.22	'05.09.26	'05.09.26
SCALE	5 : 1	DRAWING NO.	EDC3-152615-25	PART NO.	FX11A-80P/8-SV0.5(71)
UNITS	mm	HIROSE ELECTRIC CO., LTD.	CODE NO.	CL573-0603-7-71	1/1